# Harvatek Surface Mount LED Data Sheet
# HT-297 Series

## DISCLAIMER

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## LIFE SUPPORT POLICY

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## Product Specifications

| Product | Emission Color | Technology | Test Current $I_F$ (mA) | Luminous Intensity $I_V$ (mcd) | Forward Voltage $V_F$ (V) | Orderable Part Number |
|---|---|---|---|---|---|---|
| HT-297USD/UYG | Red / Green | AlInGaP / AlInGaP | 20 | 112.5/71.5 typ | 1.9 / 2.0 typ | HT-297USD/UYG-ZZZZ |
| HT-297USD5/NB5 | Red / Blue | AlInGaP / InGaN | 20 | 28.5/18.0 typ | 1.9 / 3.3 typ | HT-297USD/NB-ZZZZ |
| HT-297USD/NG | Red / Green | AlInGaP / InGaN | 20 | 112.5/71.5 typ | 1.9 / 3.3 typ | HT-297USD/NG-ZZZZ |

| | Specification | Material | Quantity |
|---|---|---|---|
| Resin | Diffused | Epoxy resin | |
| Carrier tape | Per EIA 481-1A specs | Conductive black tape | 4000pcs per reel |
| Reel | Per EIA 481-1A specs | Conductive black | |
| Label | HT standard | Paper | |
| Packing bag | 220x240mm | Aluminum laminated bag/ no-zipper | One reel per bag |
| Carton | HT standard | Paper | |

Others:

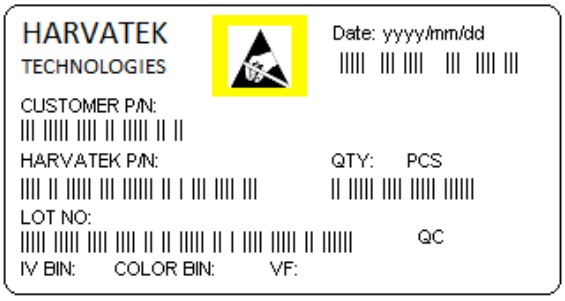
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, $\lambda_D$ and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

## ATTENTION: Electrostatic Discharge (ESD) protection

The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

## Label Specifications




## ■ Harvatek P/N:

**H T - 2 9 7 XXX / YYY- ZZZZ**

| Series Name | Emitting Color | Customer Code |
|---|---|---|
| **HT-297**<br>**HT: Harvatek**<br>**297: 0603 bicolor series**<br>**1.6 (L) x 0.8 (W) x 0.5 (H) mm** | **XXX / YYY**<br>**UYG: Ultra Bright Yellow Green**<br>**USD: Ultra Bright Red**<br>**NB: Blue**<br>**NG: Green** | **ZZZZ**<br>**Customer Product Code (TBD)** |

## Lot No.:

| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
|---|---|---|---|---|---|---|---|---|---|
| E | 1 | A | 1 | A | 2 | 2 | L | 1 | 2 |

| Code 1 2 | Code 3 | Code 4 | Code 5 | Code 6 | Code 7 | Code 8 | Code 9 | Code 10 |
|---|---|---|---|---|---|---|---|---|
| | Mfg. Year | Mfg. Month | Mfg. Date | Consecutive number | | Special code | | |
| Internal Tracing Code | 2010-A<br>2011-B<br>2012-C<br>2013-D<br>.<br>. | 1:Jan.<br>2:Feb.<br>....<br>A:Oct.<br>B:Nov.<br>C:Dec. | 1:A<br>2:B<br>3:C<br>...<br>26:Z<br>27:7<br>28:8<br>29:9<br>30:3<br>31:4 | 01~ZZ | | 000~ZZZ | | |

## Luminous Intensity (Iv) Bin:

| Bin | Luminous Intensity Range (mcd) | | Bin | Luminous Intensity Range (mcd) | |
|---|---|---|---|---|---|
| | Minimum | Maximum | | Minimum | Maximum |
| H1 | 2.8 | 3.6 | H2 | 3.6 | 4.5 |
| J1 | 4.5 | 5.7 | J2 | 5.7 | 7.2 |
| K1 | 7.2 | 9.0 | K2 | 9.0 | 11.2 |
| L1 | 11.2 | 14.2 | L2 | 14.2 | 18.0 |
| M1 | 18.0 | 22.5 | M2 | 22.5 | 28.5 |
| N1 | 28.5 | 36.0 | N2 | 36.0 | 45.0 |
| P1 | 45.0 | 57.0 | P2 | 57.0 | 71.5 |
| Q1 | 71.5 | 90.0 | Q2 | 90.0 | 112.5 |
| R1 | 112.5 | 142.0 | R2 | 142.0 | 180.0 |
| S1 | 180.0 | 227.0 | S2 | 227.0 | 285.0 |
| T1 | 285.0 | 360.0 | T2 | 360.0 | 450.0 |
| U1 | 450.0 | 570.0 | U2 | 570.0 | 715.0 |

@20mA / Ta=25$^{O}$ C, Tolerance: ± 10%

## ■ Wavelength ($\lambda_D$) Bin:

| Bin | Wavelength Range (nm) | | | | | | | |
|---|---|---|---|---|---|---|---|---|
| | Red (USD) | | Yellow Green (UYG) | | Blue (NB) | | Green (NG) | |
| | Min | Max | Min | Max | Min | Max | Min | Max |
| - | 615.0 | 630.0 | | | | | | |
| A | | | 561.5 | 564.5 | 460.0 | 464.0 | 515.0 | 520.0 |
| B | | | 564.5 | 567.5 | 464.0 | 468.0 | 520.0 | 525.0 |
| C | | | 567.5 | 570.5 | 468.0 | 472.0 | 525.0 | 530.0 |
| D | | | 570.5 | 573.5 | 472.0 | 476.0 | 530.0 | 535.0 |
| E | | | 573.5 | 576.5 | 476.0 | 480.0 | 535.0 | 540.0 |
| F | | | | | 480.0 | 485.0 | | |

@20mA / Ta=25$^{O}$ C, Tolerance: ± 0.5nm

## ■ Forward Voltage ($V_F$) Bin:

| Color | Bin Code | Spec. Range |
|---|---|---|
| Blue (NB) Green (NG) | G8 | 2.7-2.9 V |
| | H7 | 2.9-3.1 V |
| | H8 | 3.1-3.3 V |
| | J7 | 3.3-3.5 V |
| | J8 | 3.5-3.7 V |
| | K7 | 3.7-3.9 V |
| Ultra Bright (UYG, USD) | - | 2.4 V max |

@20mA / Ta=25℃, Tolerance: ± 0.05 V

## Product Characteristics

### Absolute Maximum Ratings

| Product | Emission Color | $P_d$ (mW) | $I_F$ (mA) | $I_{FP}$* (mA) | $V_R$ (V) | $T_{OP}$ (°C) | $T_{ST}$ (°C) |
|---|---|---|---|---|---|---|---|
| HT-297USD/UYG | Red / Green | 72 / 72 | 30 / 30 | 100 / 100 | 5 | -30°C~+85°C | -40°C~+90°C |
| HT-297USD5/NB5 | Red / Blue | 72 / 78 | 30 / 25 | 100 / 80 | | | |
| HT-297USD/NG | Red / Green | | | | | | |

* Condition for $I_{FP}$ is pulse of 1/10 duty and 0.1msec width

**Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

### Electro-Optical Characteristics

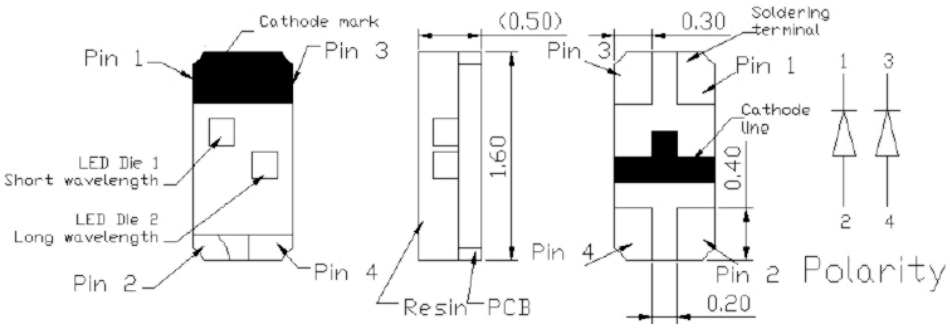
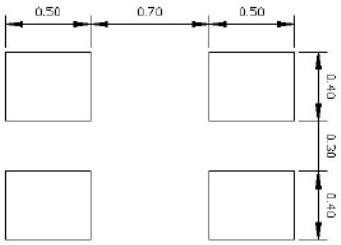
($T_a$ = 25 °C)

| Product | Emission Color | $I_F$(mA) | $V_F$(V) | | λ(nm) | | | $I^*_V$(mcd) |
|---|---|---|---|---|---|---|---|---|
| | | | typ | max | $\lambda_D$ | $\lambda_P$ | $\triangle\lambda$ | typ |
| HT-297USD/UYG | Red / Green | 20 | 1.9 / 2.0 | 2.4 / 2.4 | 622 / 573 | 636 / 574 | 17 / 20 | 112.5/71.5 |
| HT-297USD5/NB5 | Red / Blue | 5 | 1.9 / 3.3 | 2.4 / 3.9 | 622 / 470 | 636 / 468 | 17 / 40 | 28.5/18.0 |
| HT-297USD/NG | Red / Green | 20 | 1.9 / 3.3 | 2.4 / 3.9 | 622 / 527 | 636 / 520 | 17 / 40 | 112.5/71.5 |

* Per NIST standards

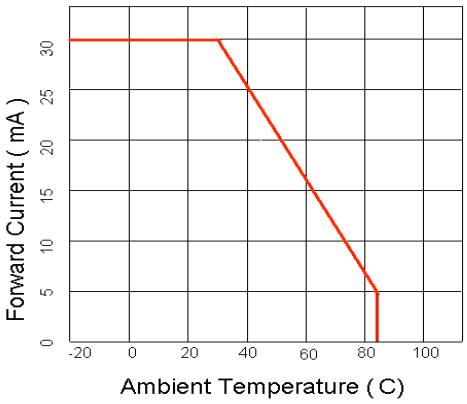
## Package Outline Dimension
## Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

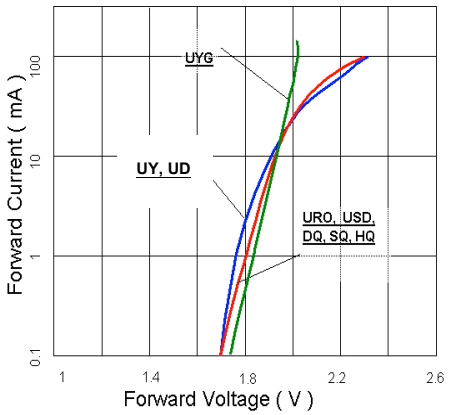
| Outline Dimension | Solder Pattern |
|---|---|
|  <br>Die 1( UYG ) - Pin 1 + Pin 2<br>Die 2( USD) - Pin 3+ Pin 4<br>In general, wavelength of Die 1 < or = Die 2 |  |
| Soldering terminals may shift in the x, y direction. | Unit: mm |

## Characteristic Curves for UYG and USD

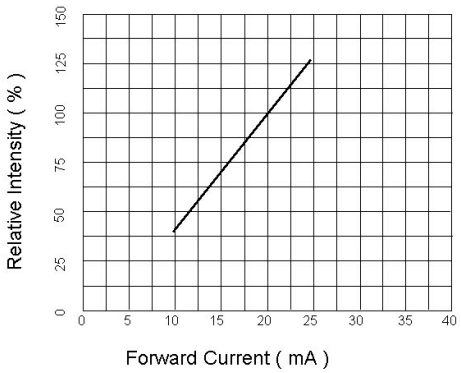
Forward Current vs. Ambient Temperature




Forward Voltage vs. Forward Current

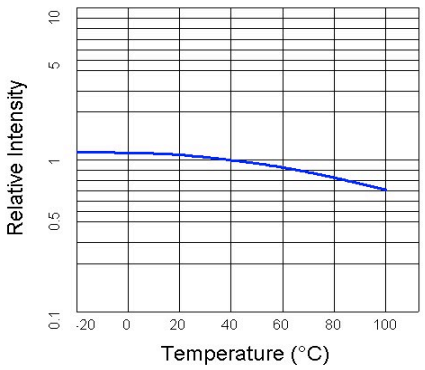



Relative Intensity vs. Forward Current

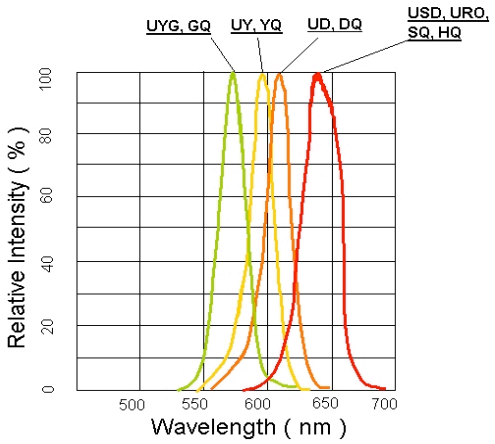



Relative Intensity vs. Ambient Temperature

Plused 20mA; 300us pulse, 10ms peroid

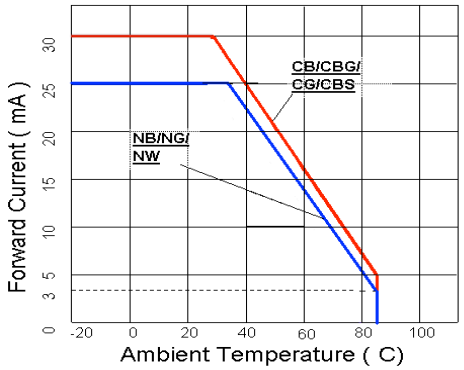



Relative Intensity vs. Wavelength

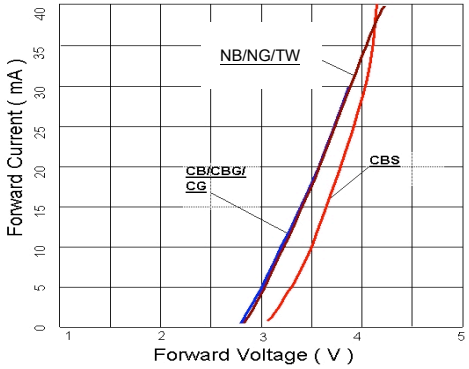


## Characteristic Curves for NB and NG

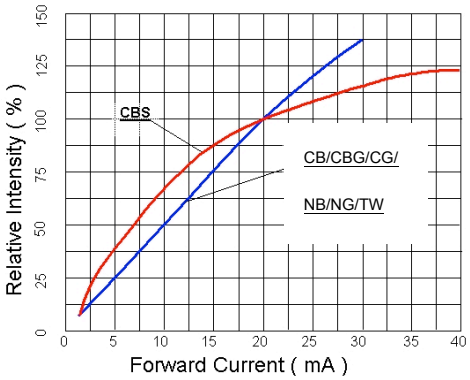
Forward Current vs. Ambient Temperature




Forward Voltage vs. Forward Current

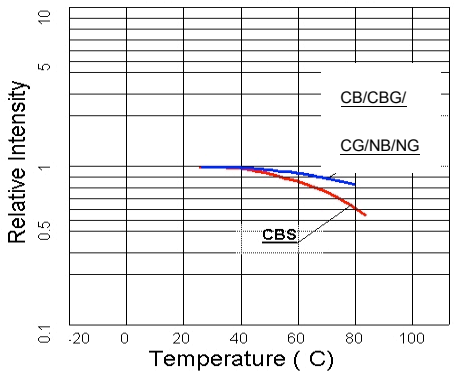



Relative Intensity vs. Forward Current

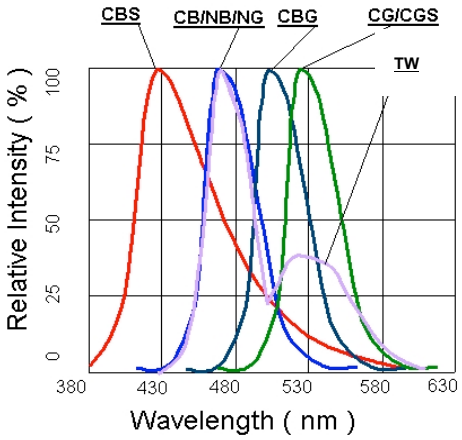



Relative Intensity vs. Ambient Temperature

Plused 20mA; 300us pulse, 10ms peroid

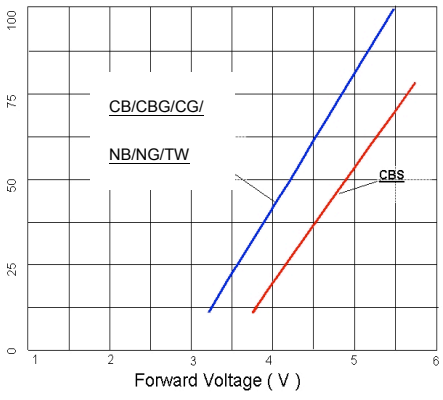



Relative Intensity vs. Wavelength

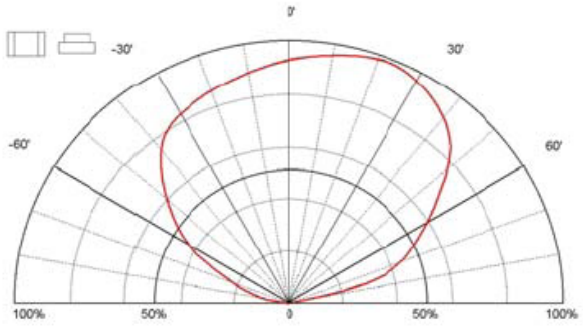
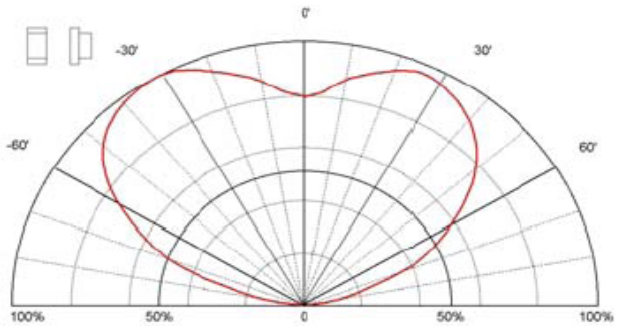



Peak Forward Voltage vs. Forward Current

100's test pulse, 1% duty cycle

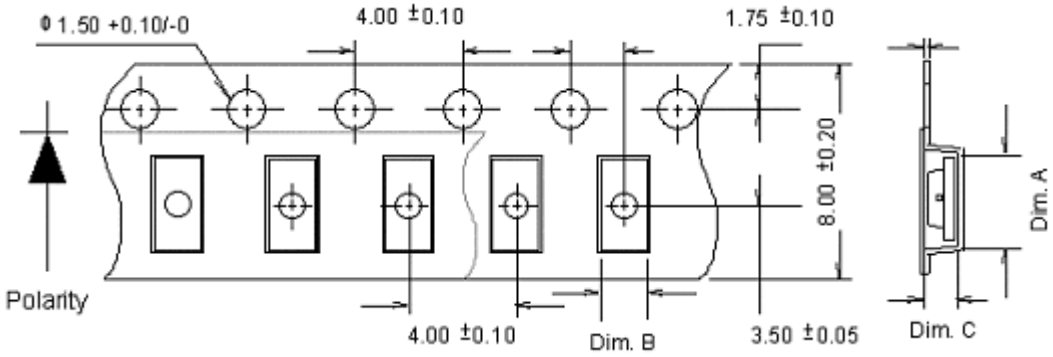



## Characteristic Curves for All Colors (Radiation Pattern)

| Directive Characteristics | Directive Characteristics |
|---|---|
|  |  |

## Packaging

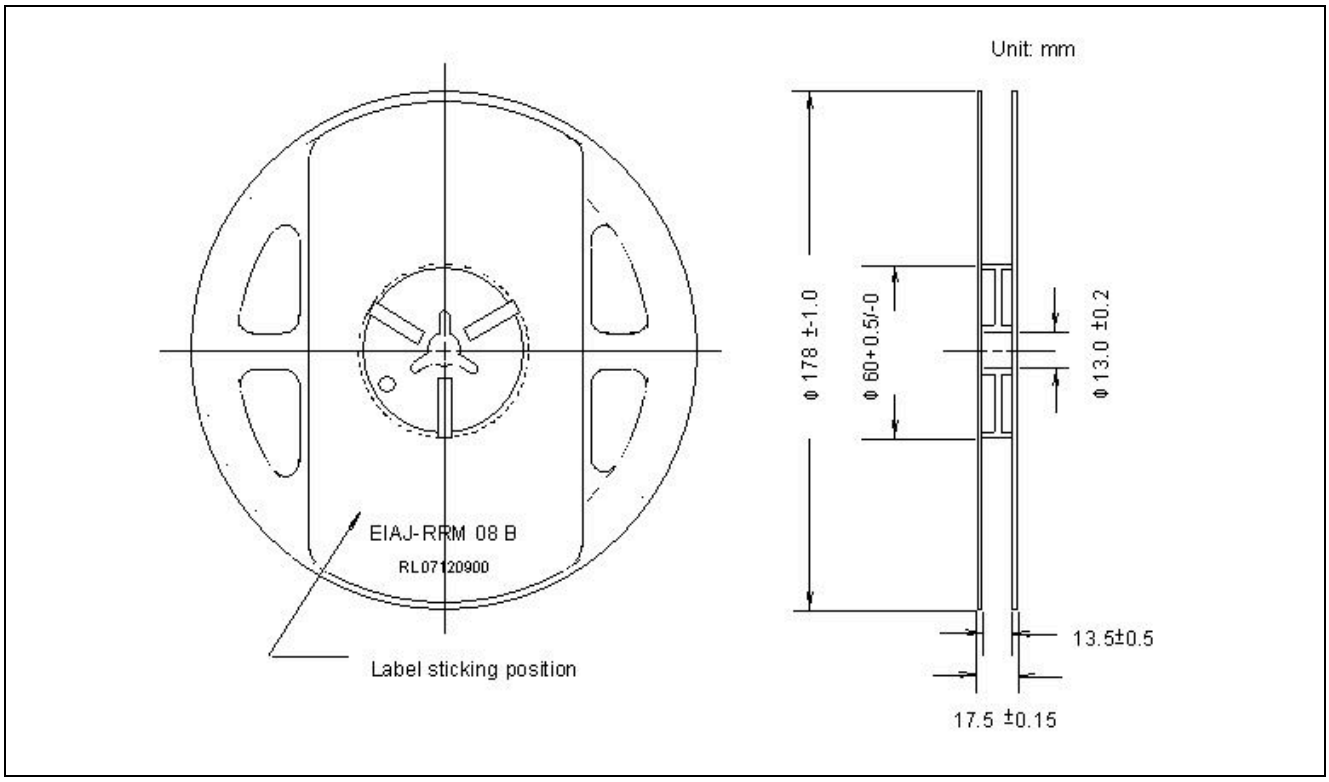
## Tape Dimension



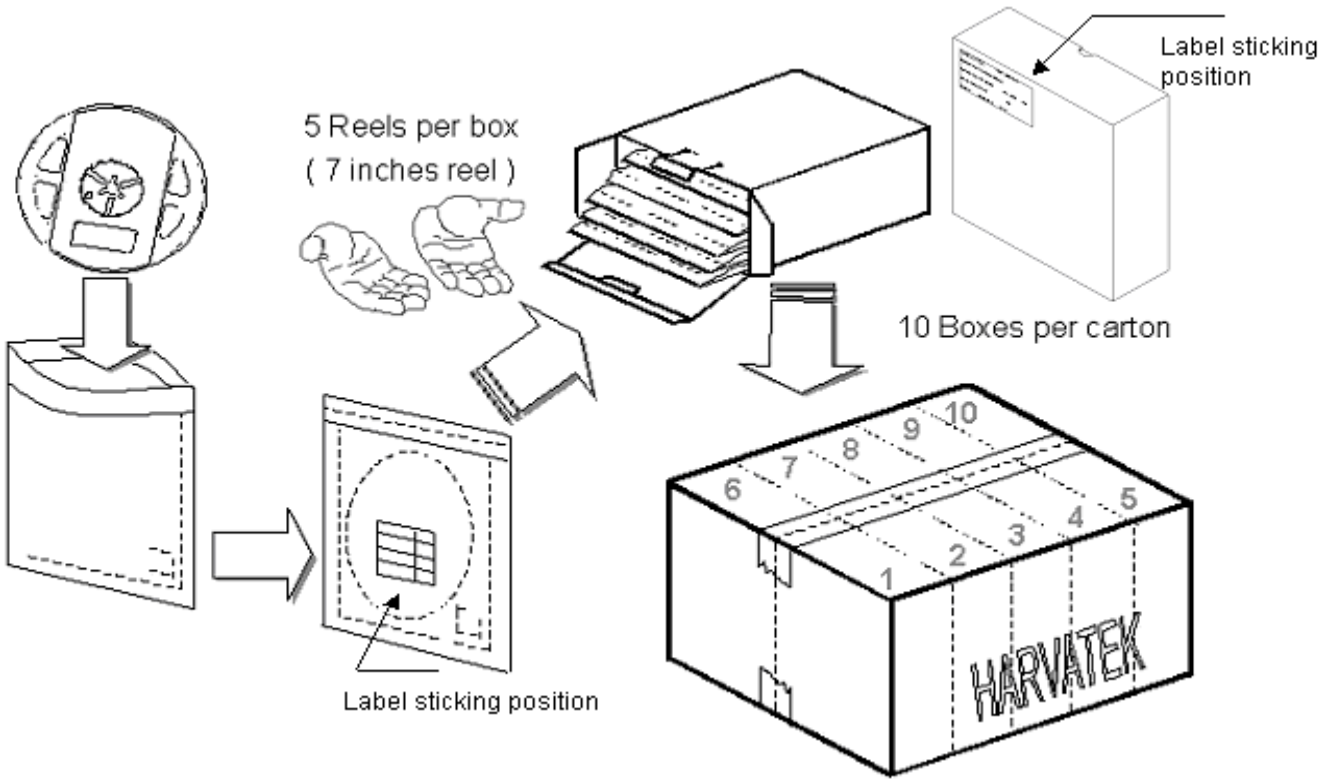

| Part No. | Dim. A | Dim. B | Dim. C | Q'ty/Reel |
|---|---|---|---|---|
| HT-297 | 1.75± 0.10 | 0.90± 0.10 | 0.60± 0.10 | 4K |

Unit: mm

## Reel Dimension



## Packing




5 boxes per carton is available depending on shipment quantity.

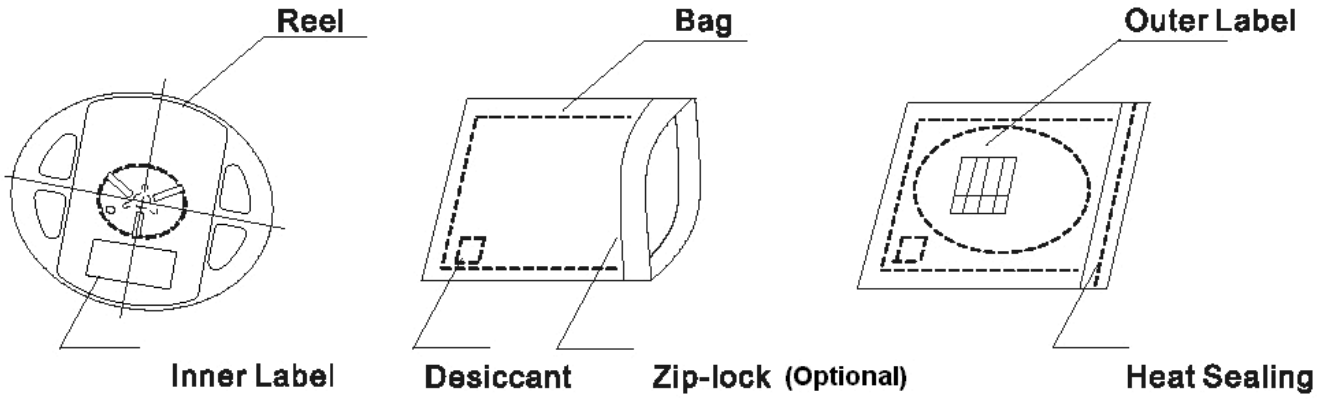
| | Specification | Material | Quantity |
|---|---|---|---|
| Carrier tape | Per EIA 481-1A specs | Conductive black tape | 4000pcs per reel |
| Reel | Per EIA 481-1A specs | Conductive black | |
| Label | HT standard | Paper | |
| Packing bag | 220x240mm | Aluminum laminated bag/ no-zipper | One reel per bag |
| Carton | HT standard | Paper | Non-specified |
| Others:<br>Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, $\lambda_D$ and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well. | | | |

## Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

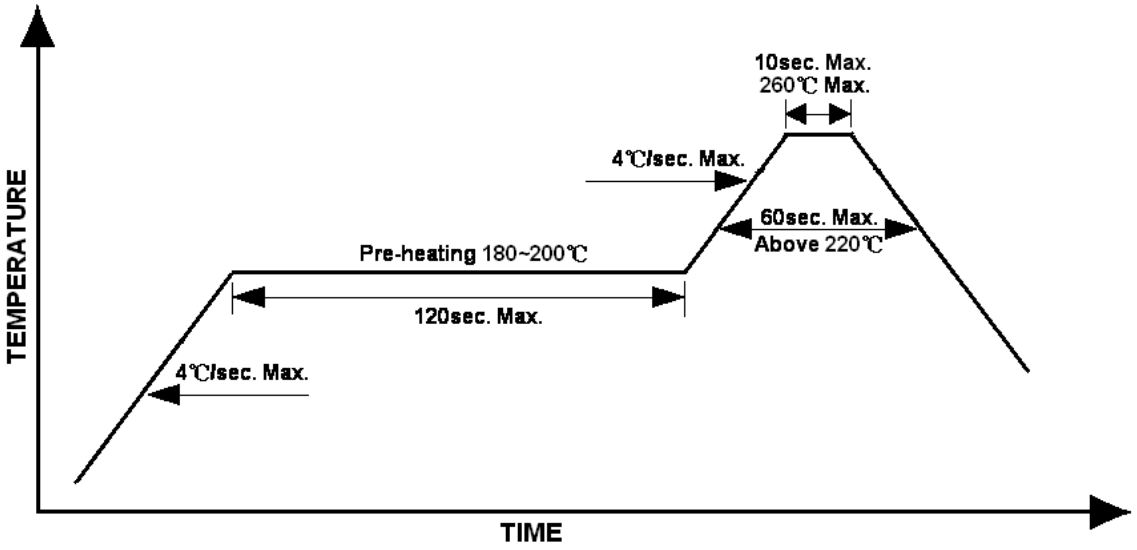
The packaging sequence is as follows:



## Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 $^{O}$C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile




## Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

## Reworking

- Rework should be completed within 5 seconds under 260 $^{O}$C.
- The iron tip must not come in contact with the copper foil.

- Twin-head type is preferred.

**Cleaning**

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

**Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

## Revision History

| Changes since last revision | Page | Version No. | Revision Date |
|---|---|---|---|
| Initial Release | | V1.0 | 06-19-2013 |
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